



Vincotech

flowPIM 1 + PFC		600 V / 30 A
Topology features		flow 1 12 mm housing
<ul style="list-style-type: none">• 2-leg interleaved PFC + Inverter• On-board Capacitors• Open Emitter configuration• Shunt• Temperature sensor		
Component features		
<ul style="list-style-type: none">• 5us short circuit withstand time• High speed switching• Low EMI• Short tail current		
Housing features		Schematic
<ul style="list-style-type: none">• Base isolation: Al₂O₃• Convex shaped substrate for superior thermal contact• Thermo-mechanical push-and-pull force relief• Press-fit pin• Reliable cold welding connection		
Target applications		
<ul style="list-style-type: none">• Embedded Drives• Industrial Drives		
Types		
<ul style="list-style-type: none">• 10-PG06PPA030SJ01-LH52E08T		



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	30	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	63	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150^\circ\text{C}$	5	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	28	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	40	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
PFC Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	29	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	68	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	46	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $T_j = 25^\circ\text{C}$ $t_p = 10 \text{ ms}$	310	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	60	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

PFC Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	16	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	12	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	38	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Inverter Shunt

DC current	I		31,6	A
Power dissipation	P_{tot}	$T_c = 70^\circ\text{C}$	2	W
Operation Temperature	T_{op}		-65 ... 170	$^\circ\text{C}$

PFC Shunt

DC current	I		31,6	A
Power dissipation	P_{tot}	$T_c = 70^\circ\text{C}$	2	W
Operation Temperature	T_{op}		-65 ... 170	$^\circ\text{C}$

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Maximum Ratings

 $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Shunt				
DC current	I		63,2	A
Power dissipation	P_{tot}	$T_c = 70 \text{ }^\circ\text{C}$	4	W
Operation Temperature	T_{op}		-65 ... 170	$^\circ\text{C}$

Capacitor (PFC)

Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 150	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				8,05	mm
Comparative Tracking Index	CTI			≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00048	25	4,1	5,1	5,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 125 150		1,73 1,97 2,01	1,8 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			1,6	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{res}	$f = 1 \text{ MHz}$	0	25	25	25		1050		pF
Output capacitance	C_{oes}							45		pF
Reverse transfer capacitance	C_{res}							36		pF
Gate charge	Q_g	$V_{CC} = 480 \text{ V}$	15		30	25		130		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,52		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	30	25		37		
Rise time	t_r					125		38		ns
Turn-off delay time	$t_{d(off)}$					150		15		
Fall time	t_f					25		90		
Turn-on energy (per pulse)	E_{on}					125		109		
Turn-off energy (per pulse)	E_{off}					150		113		
		$Q_{fFWD}=0,812 \mu\text{C}$ $Q_{rfFWD}=1,81 \mu\text{C}$ $Q_{ffFWD}=2,02 \mu\text{C}$				25		12		
						125		19,35		
						150		23,06		
						25		0,758		
						125		0,981		mWs
						150		1,04		
						25		0,233		
						125		0,422		
						150		0,469		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inverter Diode

Static

Forward voltage	V_F				20	25 125 150	1,25	1,7 1,58 1,58	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 600$ V			25			27	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,91		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=500$ A/ μ s $di/dt=1295$ A/ μ s $di/dt=1294$ A/ μ s	± 15	350	30	25 125 150		7,86 12,39 13,22		A
Reverse recovery time	t_{rr}					25 125 150		200,95 276,23 327,76		ns
Recovered charge	Q_r					25 125 150		0,812 1,81 2,02		μ C
Reverse recovered energy	E_{rec}					25 125 150		0,161 0,388 0,431		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		53,57 61,27 82,45		A/ μ s



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

PFC Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0003	25	3,3	4	4,7	V
Collector-emitter saturation voltage	V_{CEsat}		15		30	25 125		1,97 2,25	2,22 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ MHz}$	0	25	25	25		2100		pF
Output capacitance	C_{oes}							45		pF
Reverse transfer capacitance	C_{res}							7,7		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		30	25		65		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,39		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goft} = 8 \Omega$	0/15	400	30	25		15,34		
Rise time	t_r					125		15,05		
						150		14,92		ns
Turn-off delay time	$t_{d(off)}$					25		5,17		
						125		6,33		
Fall time	t_f					150		6,63		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD}=0,485 \mu\text{C}$ $Q_{rFWD}=1,27 \mu\text{C}$ $Q_{fFWD}=1,56 \mu\text{C}$				25		85,92		
						125		101,31		
						150		105,05		ns
Turn-off energy (per pulse)	E_{off}					25		2,81		
						125		9,84		
						150		11,19		ns
						25		0,324		
						125		0,502		mWs
						150		0,569		
						25		0,179		
						125		0,255		
						150		0,284		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

PFC Diode

Static

Forward voltage	V_F				30	25 125 150		1,67 1,33 1,24	2,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 600$ V				25			20	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,58		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=4701$ A/µs $di/dt=3916$ A/µs $di/dt=3651$ A/µs	0/15	400	30	25 125 150		51,45 72,06 80,39		A
Reverse recovery time	t_{rr}					25 125 150		18,4 39,47 42,63		ns
Recovered charge	Q_r					25 125 150		0,485 1,27 1,56		µC
Reverse recovered energy	E_{rec}					25 125 150		0,073 0,239 0,304		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		9845,3 7490,35 6957,28		A/µs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

PFC Sw. Protection Diode

Static

Forward voltage	V_F				6	25 125 150	1,23	1,72 1,58 1,54	1,87 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 650$ V			25			0,1	μA	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,53		K/W
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Inverter Shunt

Static

Resistance	R							2		mΩ
Temperature coefficient	t_c							275	ppm/K	

PFC Shunt

Static

Resistance	R							2		mΩ
Temperature coefficient	t_c							275	ppm/K	

Shunt

Static

Resistance	R							1		mΩ
Temperature coefficient	t_c							275	ppm/K	



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance						-5		5	%	

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5	5	%	
Power dissipation	P				25		130		mW	
Power dissipation constant	d				25		1,5		mW/K	
B-value	$B_{(25/50)}$	Tol. ±1 %					3962		K	
B-value	$B_{(25/100)}$	Tol. ±1 %					4000		K	
Vincotech Thermistor Reference								I		

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

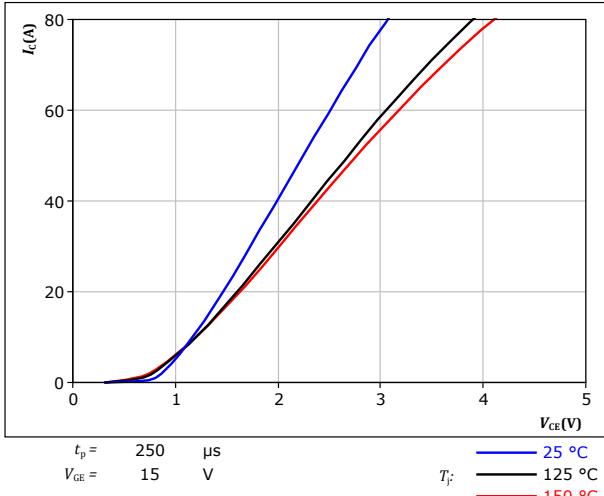


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

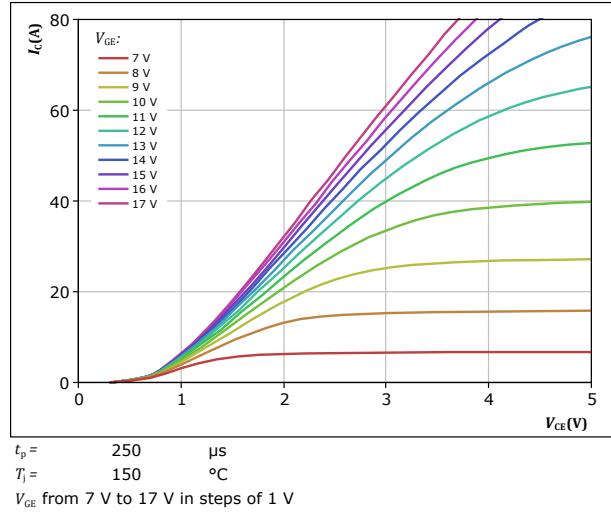


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

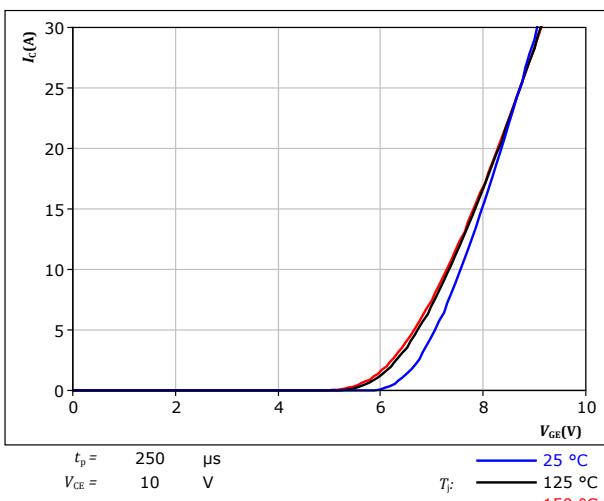
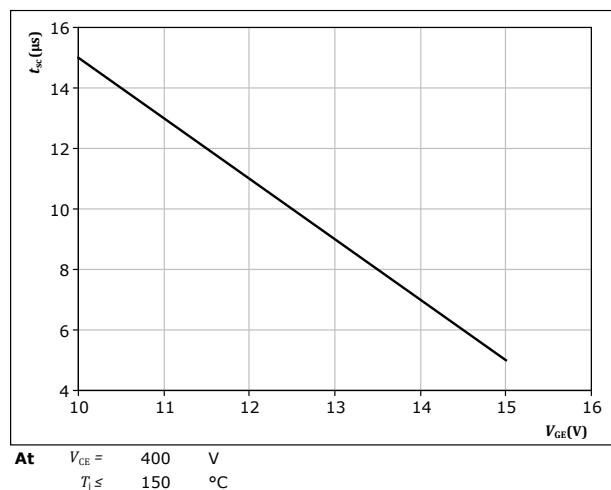


figure 4. IGBT

Short circuit withstand time as a function of V_{GE}
 $t_{sc} = f(V_{GE})$





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Inverter Switch Characteristics

figure 5. IGBT

Typical short circuit current as a function of V_{GE}
 $I_{SC} = f(V_{GE})$

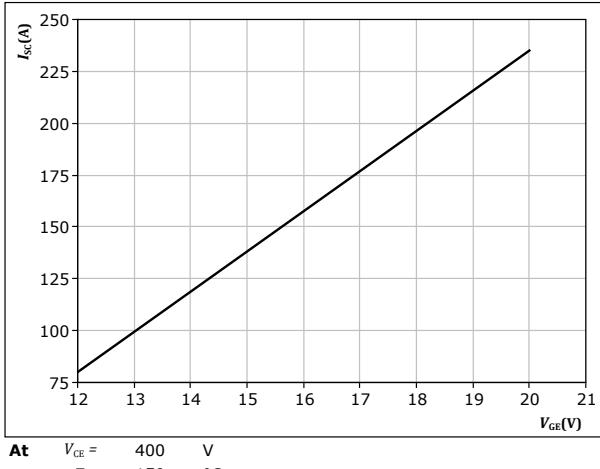
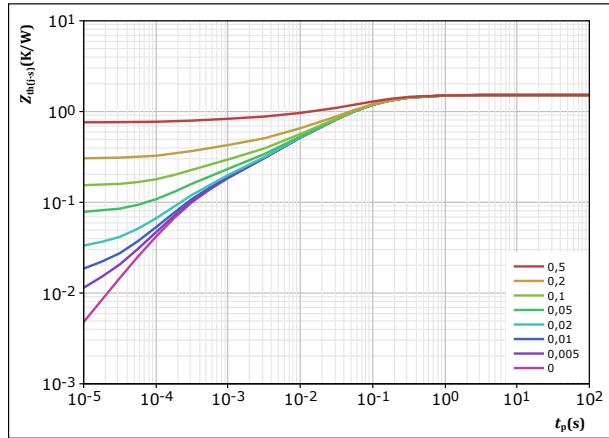


figure 6. IGBT

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



IGBT thermal model values

R (K/W)	τ (s)
1,77E-01	4,26E-01
6,88E-01	7,72E-02
3,07E-01	2,26E-02
2,02E-01	5,04E-03
6,94E-02	7,36E-04
7,56E-02	2,30E-04

figure 7. IGBT

Safe operating area
 $I_C = f(V_{CE})$

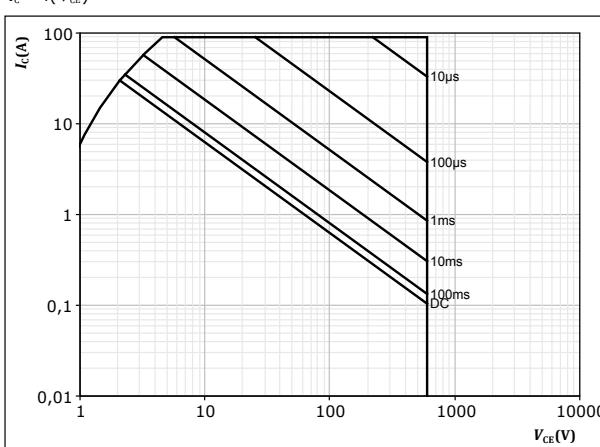
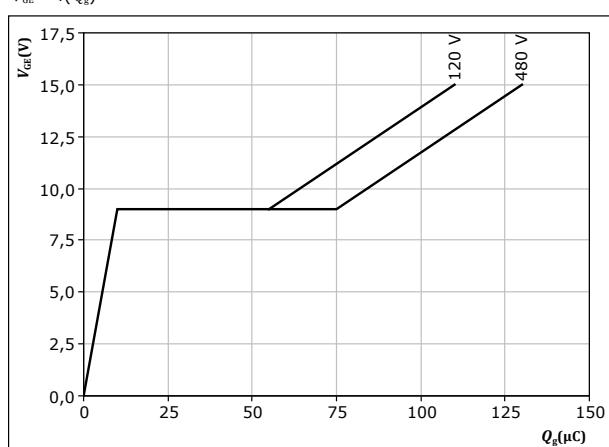


figure 8. IGBT

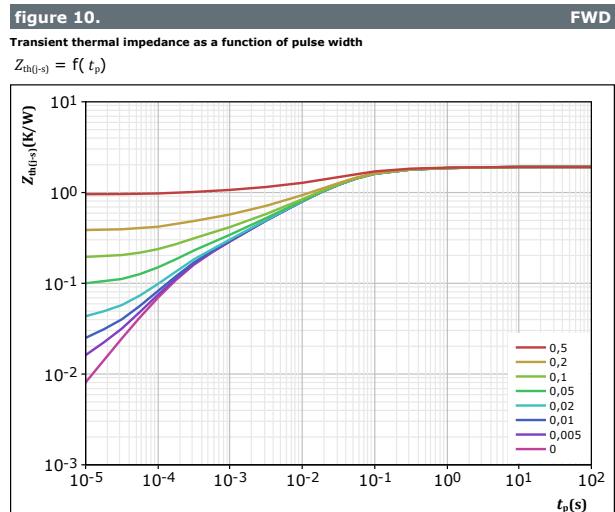
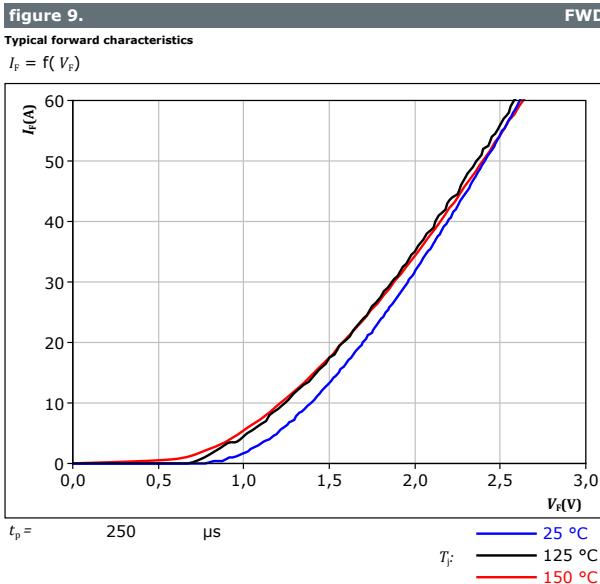
Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$





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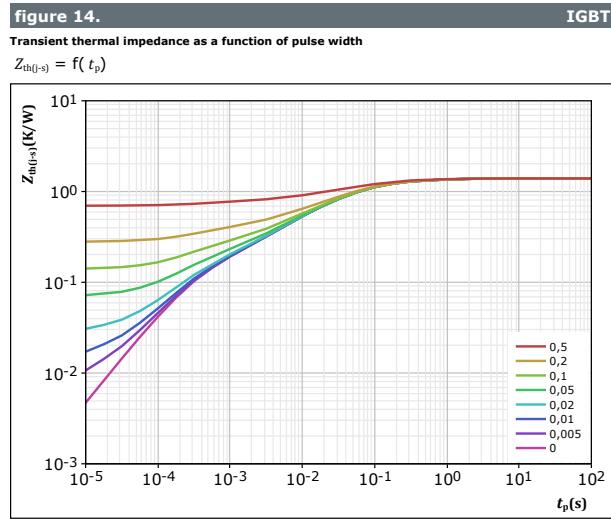
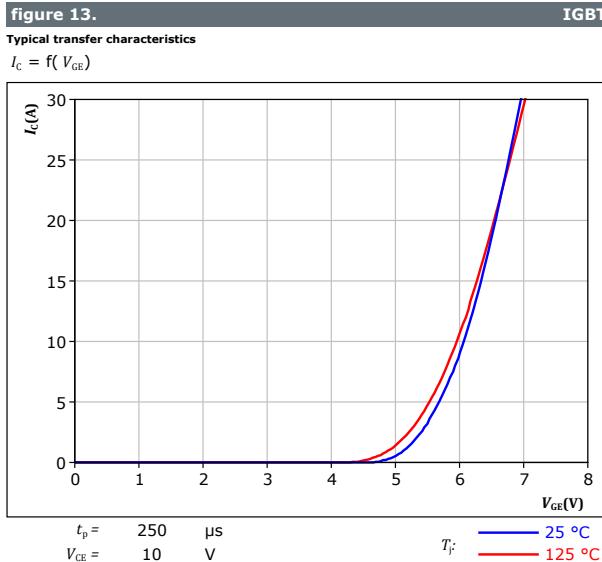
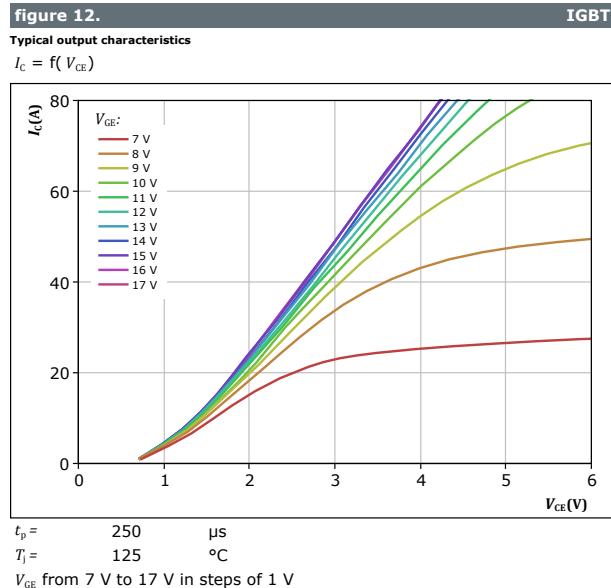
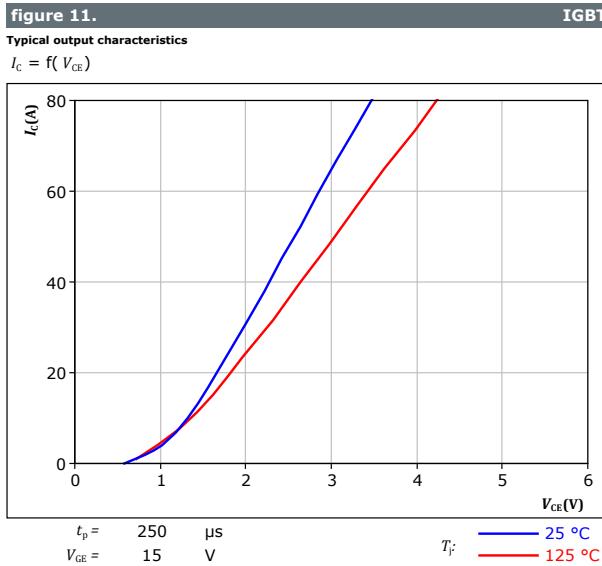
Inverter Diode Characteristics





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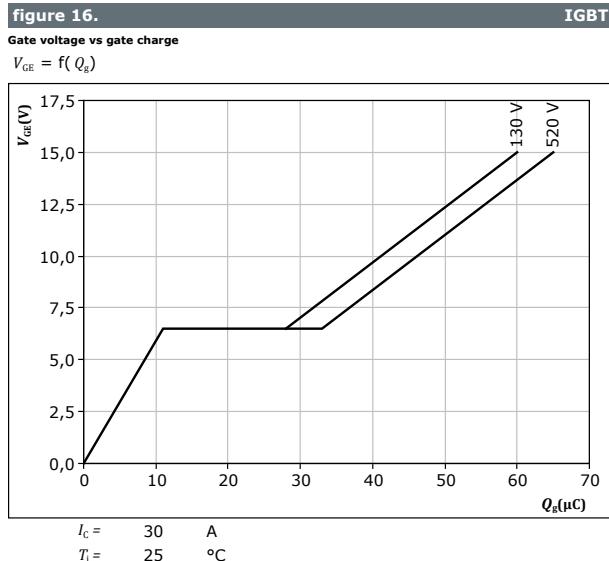
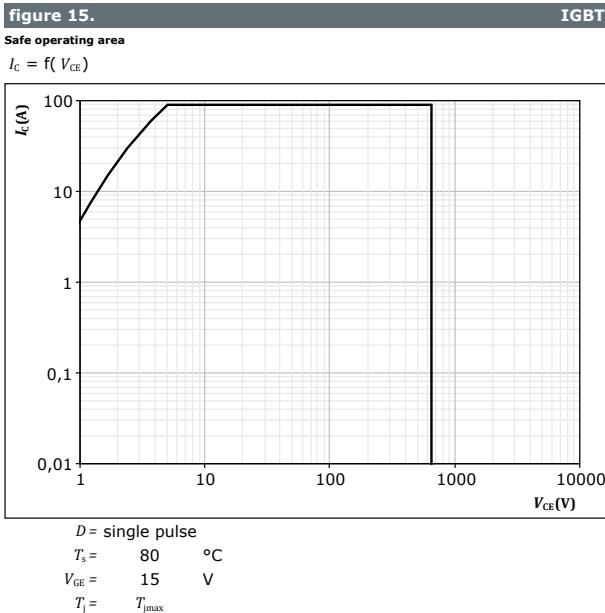
PFC Switch Characteristics





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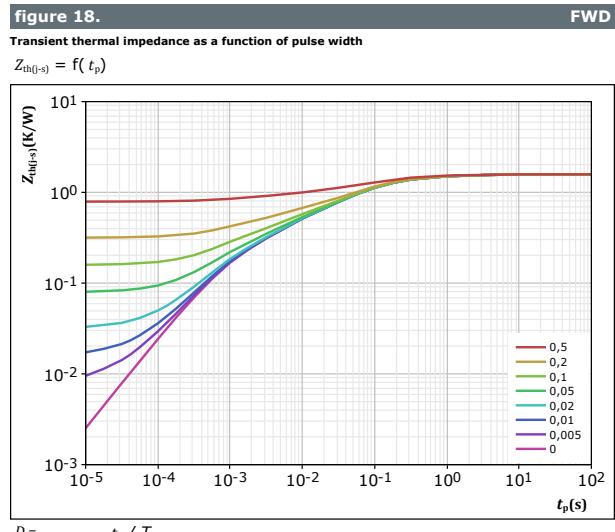
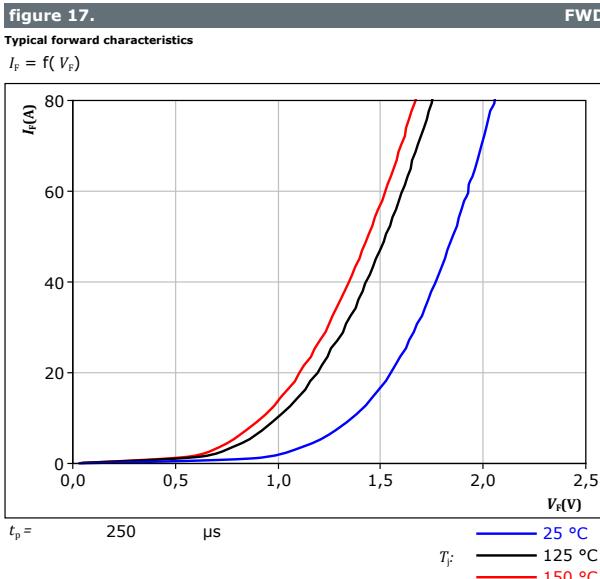
PFC Switch Characteristics





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PFC Diode Characteristics





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PFC Sw. Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

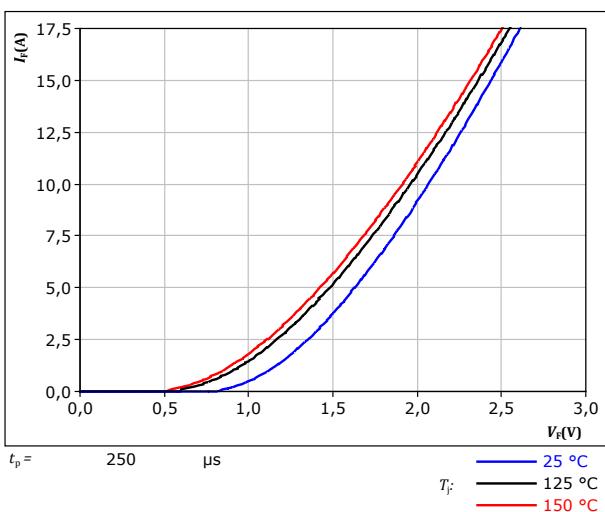
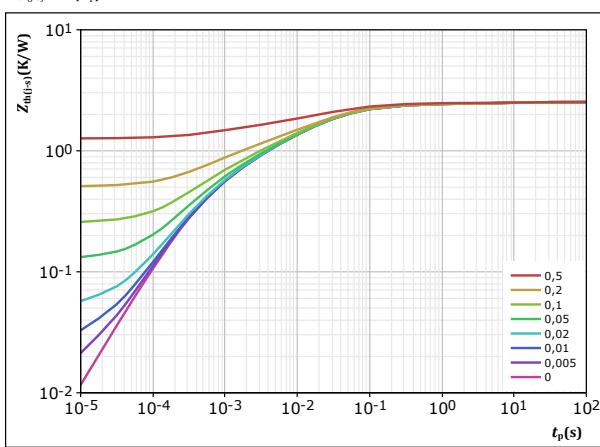


figure 20.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



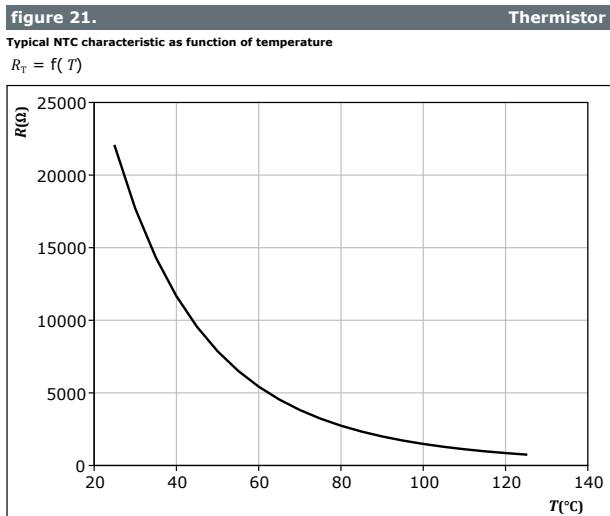
$$D = \frac{t_p / \tau}{2,527} \quad K/W$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
9,24E-02	9,29E+00
1,75E-01	3,21E-01
7,31E-01	4,97E-02
7,14E-01	1,16E-02
4,89E-01	2,11E-03
3,27E-01	3,78E-04



Thermistor Characteristics





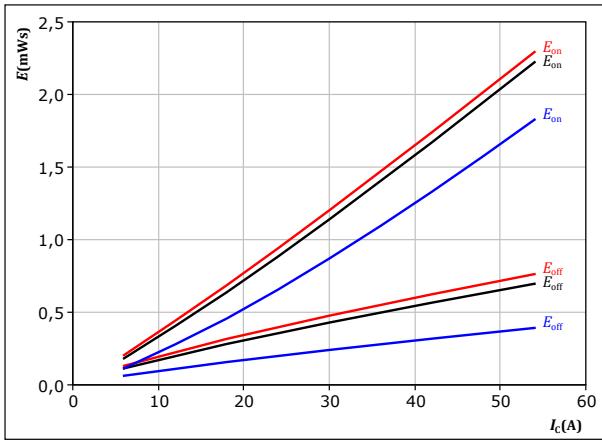
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Inverter Switching Characteristics

figure 22.

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

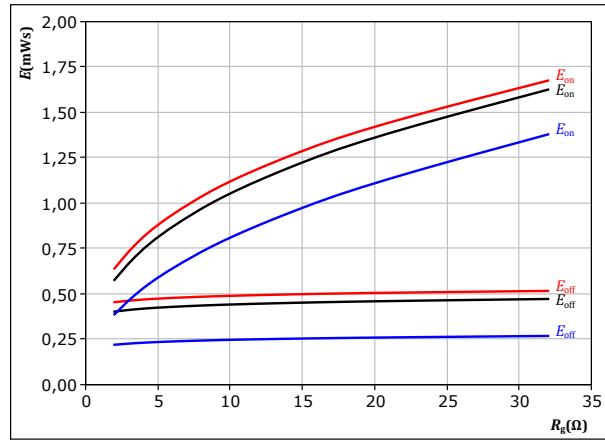
$$\begin{aligned} V_{CE} &= 350 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ R_{gon} &= 8 \quad \Omega & & 150 \text{ }^{\circ}\text{C} \\ R_{goff} &= 8 \quad \Omega \end{aligned}$$

IGBT

figure 23.

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

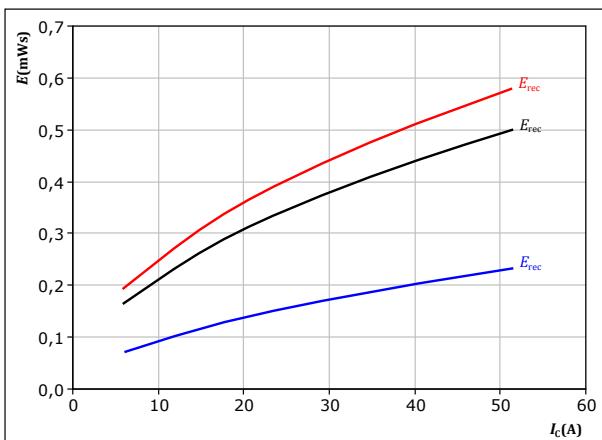
$$\begin{aligned} V_{CE} &= 350 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ I_C &= 30 \quad A & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$

IGBT

figure 24.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

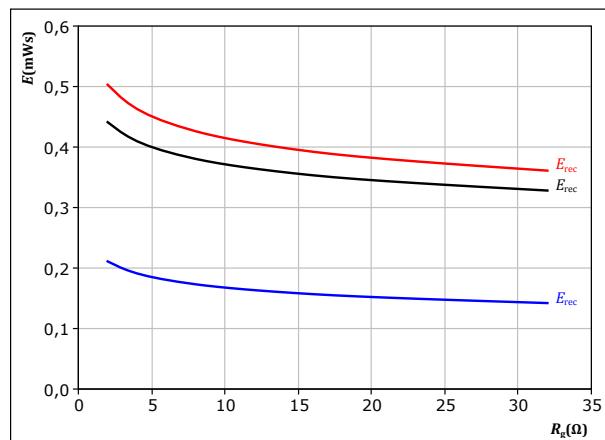
$$\begin{aligned} V_{CE} &= 350 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ R_{gon} &= 8 \quad \Omega & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$

FWD

figure 25.

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 350 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ I_C &= 30 \quad A & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$

FWD

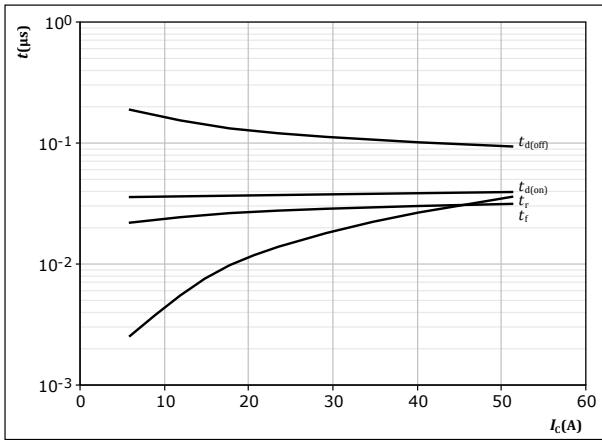


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Inverter Switching Characteristics

figure 26.

Typical switching times as a function of collector current
 $t = f(I_C)$



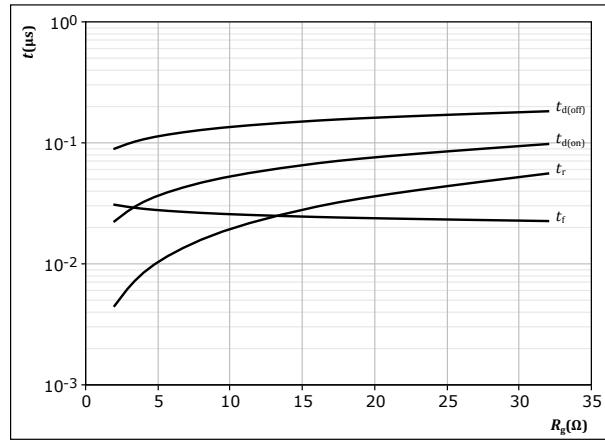
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

IGBT

figure 27.

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



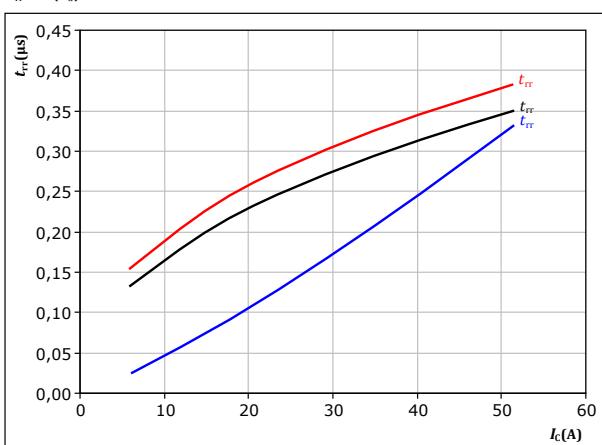
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 30 \text{ A}$

IGBT

figure 28.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



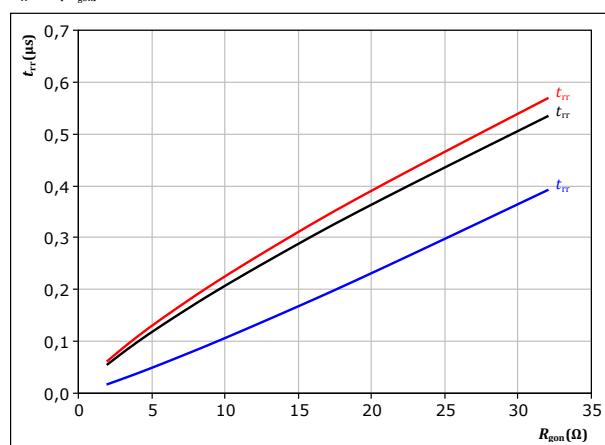
With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$

FWD

figure 29.

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 30 \text{ A}$

FWD



Vincotech

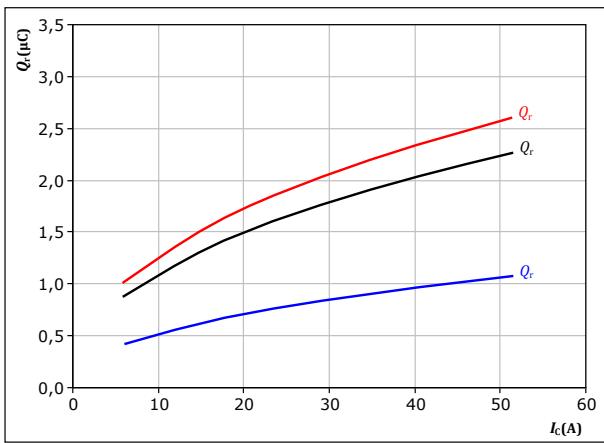
Inverter Switching Characteristics

figure 30.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

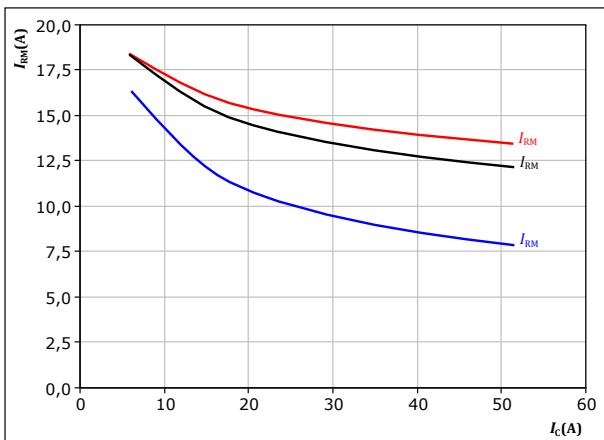
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & I_c &= 30 \text{ A} \end{aligned}$$

figure 32.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

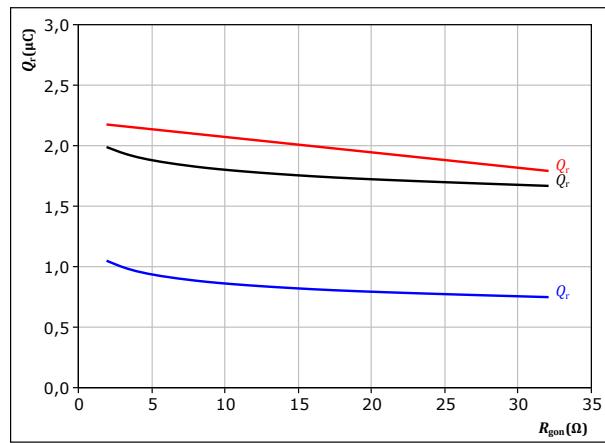
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & I_c &= 30 \text{ A} \end{aligned}$$

figure 31.

FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

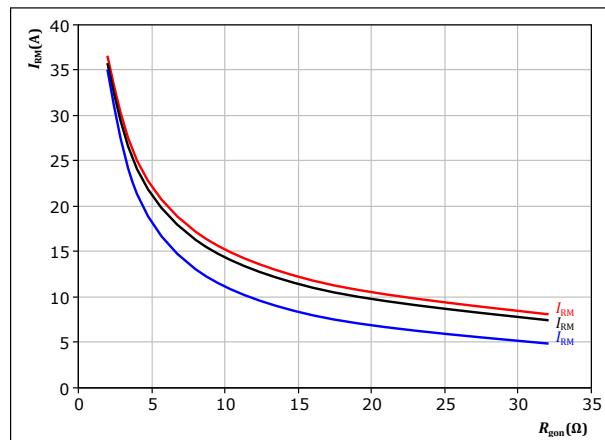
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 30 \text{ A} & R_{gon} &= 8 \Omega \end{aligned}$$

figure 33.

FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 30 \text{ A} & R_{gon} &= 8 \Omega \end{aligned}$$



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Inverter Switching Characteristics

figure 34. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

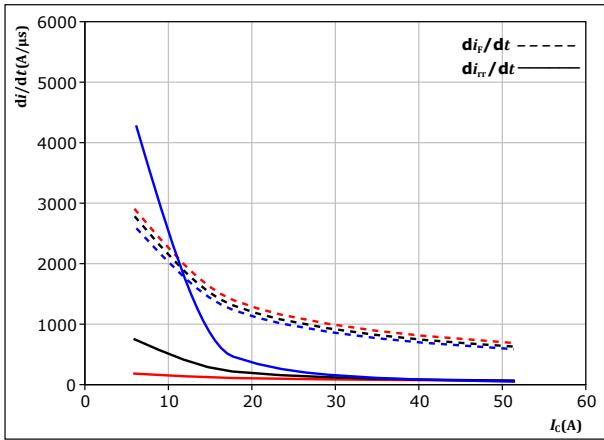


figure 35. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

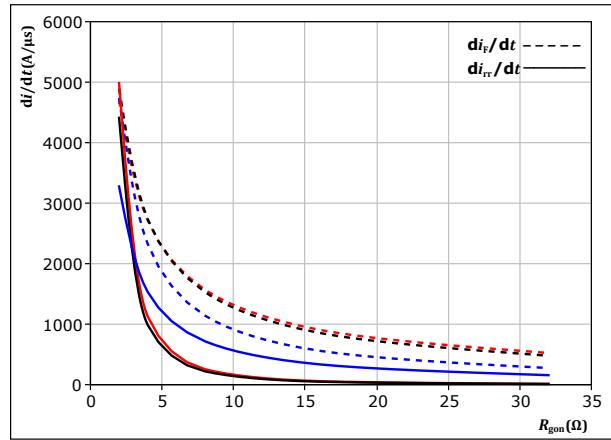
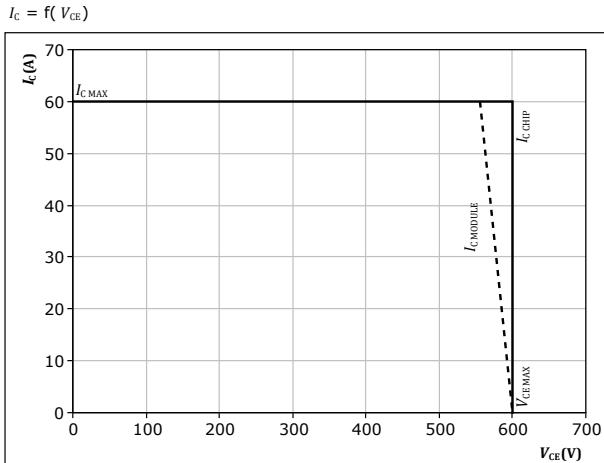


figure 36. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$





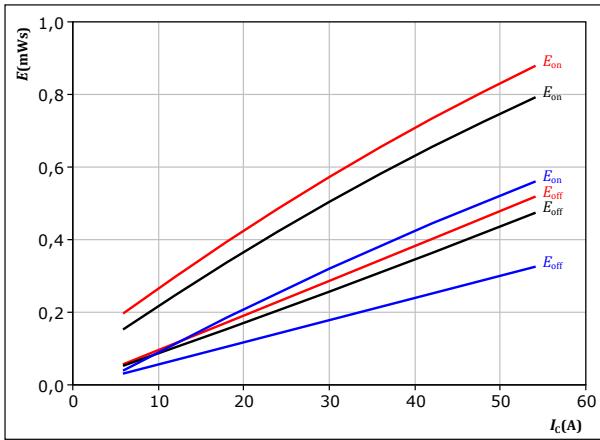
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PFC Switching Characteristics

figure 37.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

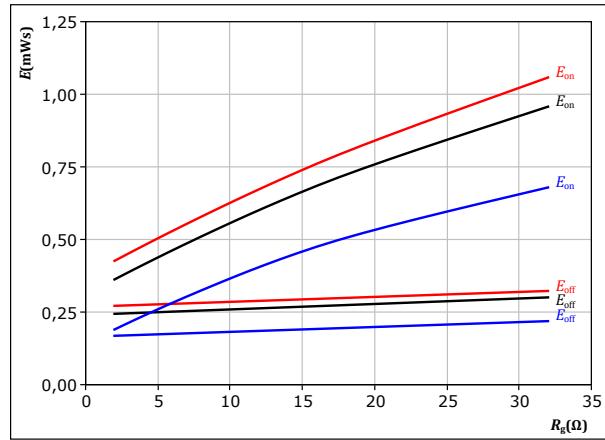
$$\begin{aligned} V_{CE} &= 400 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= 0/15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ R_{gon} &= 8 \quad \Omega & & 150 \text{ }^{\circ}\text{C} \\ R_{goff} &= 8 \quad \Omega \end{aligned}$$

IGBT

figure 38.

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



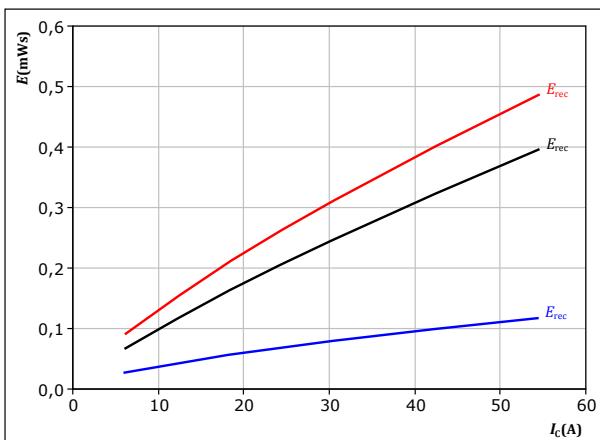
With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= 0/15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ I_c &= 30 \quad A & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$

figure 39.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

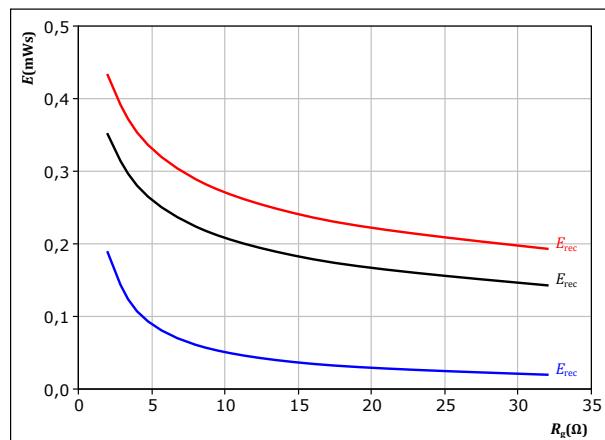
$$\begin{aligned} V_{CE} &= 400 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= 0/15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ R_{gon} &= 8 \quad \Omega & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$

FWD

figure 40.

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad V & T_f: & 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= 0/15 \quad V & & 125 \text{ }^{\circ}\text{C} \\ I_c &= 30 \quad A & & 150 \text{ }^{\circ}\text{C} \end{aligned}$$



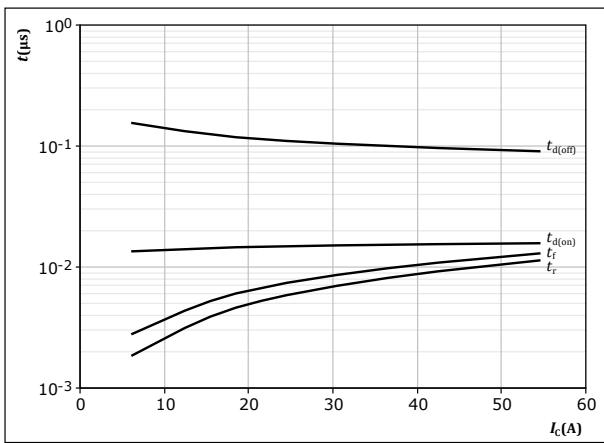
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PFC Switching Characteristics

figure 41.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



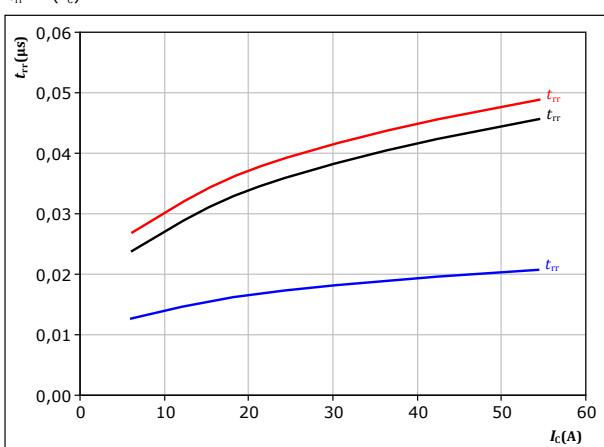
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

figure 43.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



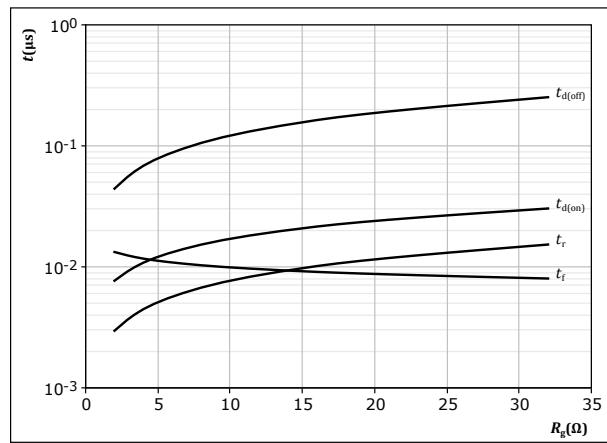
With an inductive load at

$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 8 \Omega$

figure 42.

IGBT

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



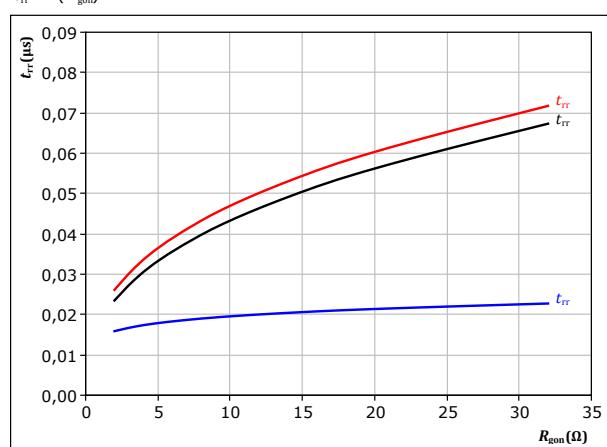
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 30 \text{ A}$

figure 44.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 30 \text{ A}$



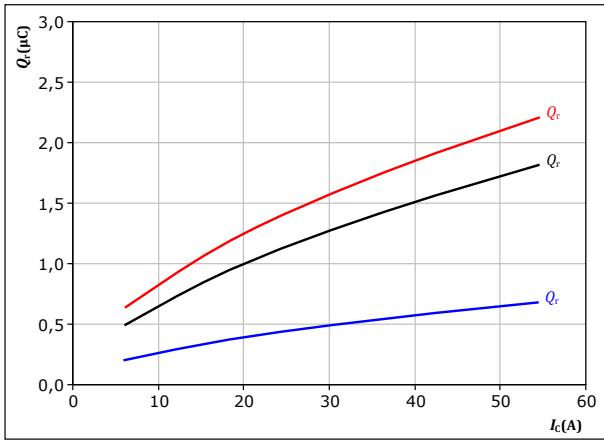
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PFC Switching Characteristics

figure 45.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

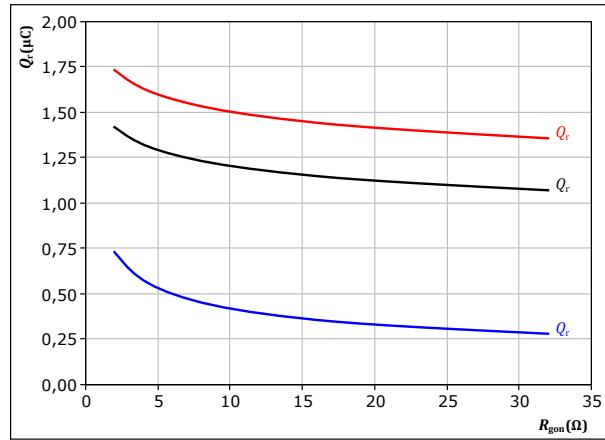
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= 0/15 \quad V \\ R_{gon} &= 8 \quad \Omega \end{aligned}$$

FWD

figure 46.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

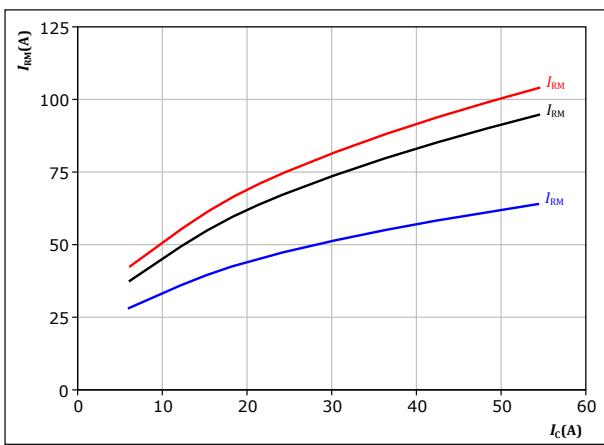
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= 0/15 \quad V \\ I_c &= 30 \quad A \end{aligned}$$

FWD

figure 47.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

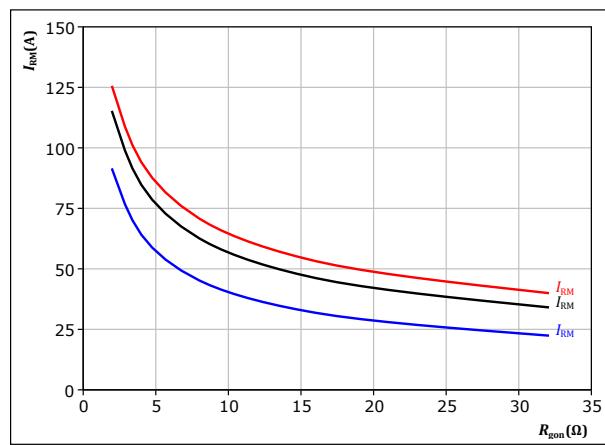
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= 0/15 \quad V \\ R_{gon} &= 8 \quad \Omega \end{aligned}$$

FWD

figure 48.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= 0/15 \quad V \\ I_c &= 30 \quad A \end{aligned}$$

FWD



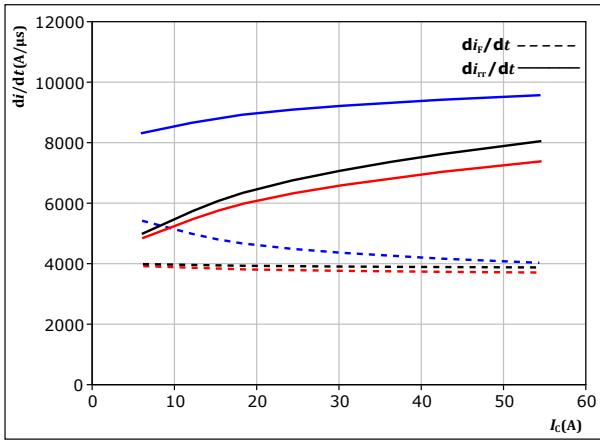
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PFC Switching Characteristics

figure 49. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

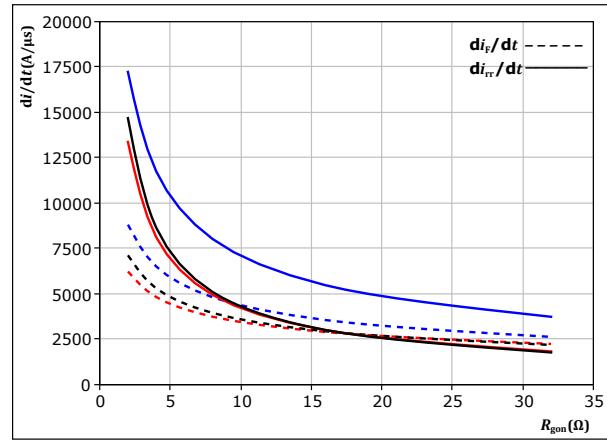
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 8$ Ω

$T_j = 25, 125, 150$ °C

figure 50. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

$di_f/dt, di_{rr}/dt = f(R_{gon})$

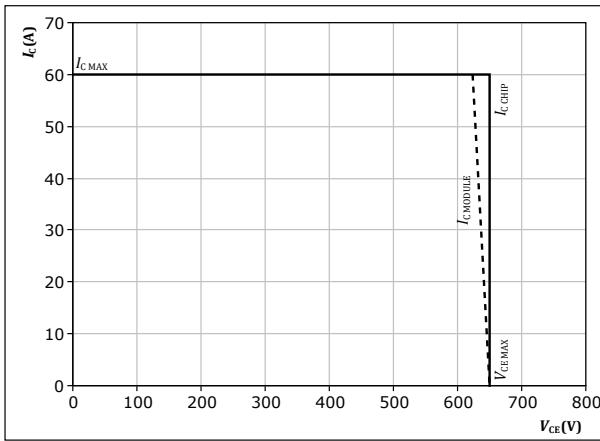


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A
 $T_j = 25, 125, 150$ °C

figure 51. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At
 $T_j = 150$ °C
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



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Switching Definitions

figure 52. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

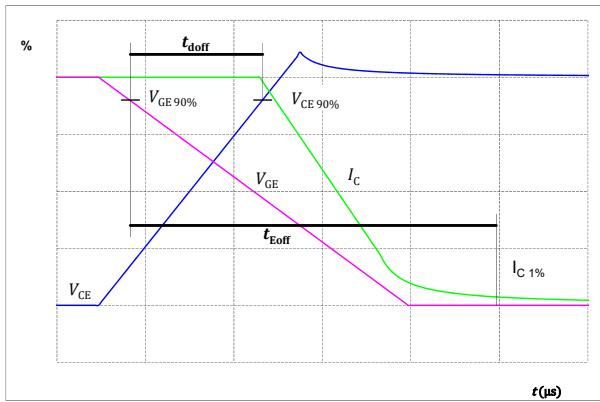


figure 53. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

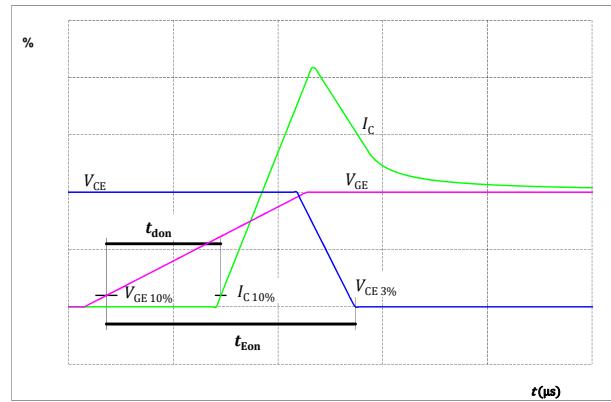


figure 54. IGBT

Turn-off Switching Waveforms & definition of t_f

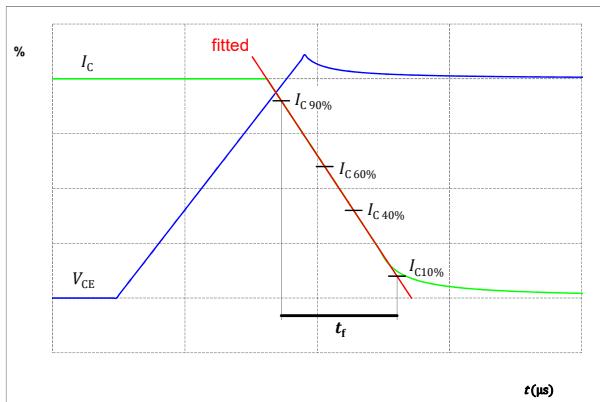
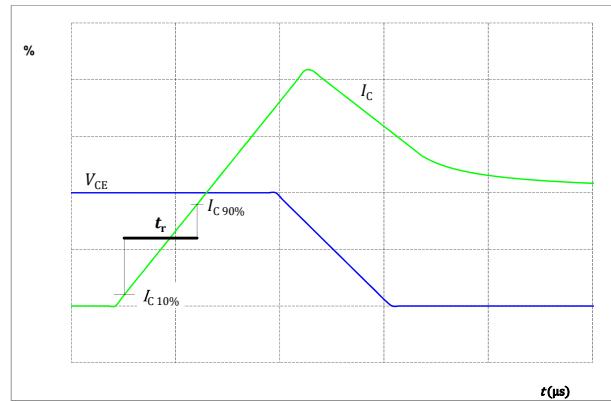


figure 55. IGBT

Turn-on Switching Waveforms & definition of t_r





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Switching Definitions

figure 56.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

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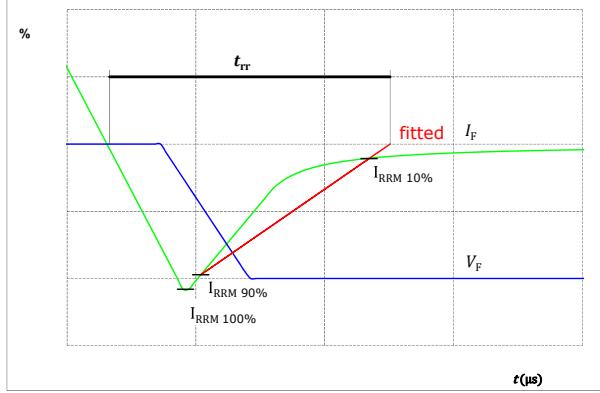
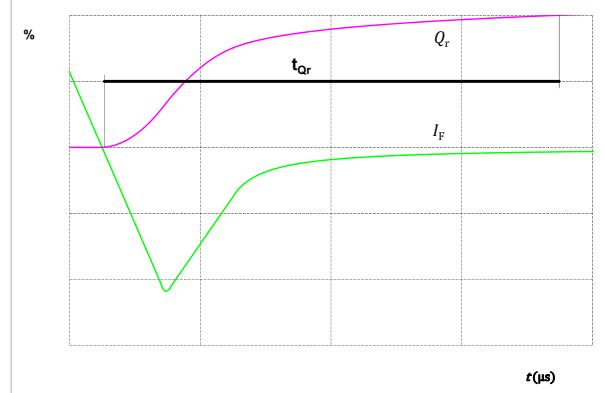


figure 57.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

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**10-PG06PPA030SJ01-LH52E08T**

datasheet

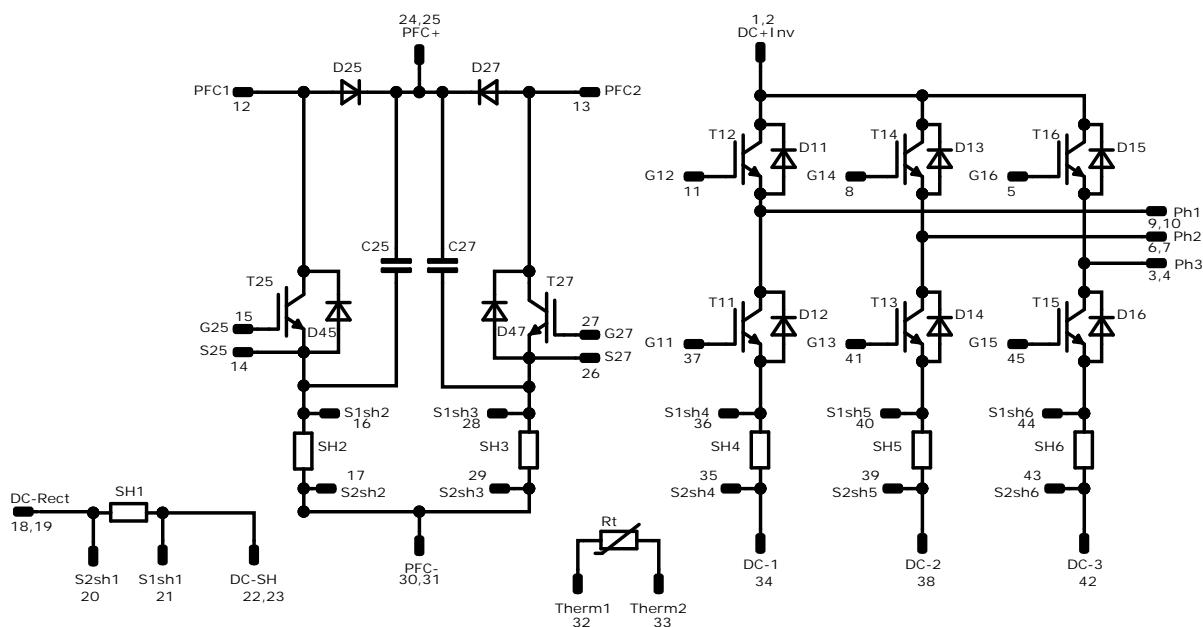
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Ordering Code							
Version				Ordering Code			
Without thermal paste				10-PG06PPA030SJ01-LH52E08T			
With thermal paste (5,2 W/mK, PTM6000HV)				10-PG06PPA030SJ01-LH52E08T-/7/			
With thermal paste (3,4 W/mK, PSX-P7)				10-PG06PPA030SJ01-LH52E08T-/3/			
Marking							
 NN-NNNNNNNNNNNN TTTTTTVV WWYY VIN LLLLLL SSSS	Text	Name NN-NNNNNNNNNNNNNN- TTTTTTVV		Date code WWYY	UL & VIN UL VIN	Lot LLLLL	
		Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	Serial SSSS	
Outline							
Pin table [mm]		 center of pins fit surface for connection parameter see the handling instruction					
Pin	X	Y	Function				
1	52,5	2,7	DC+Inv				
2	52,5	0	DC+Inv				
3	46,2	0	Ph3				
4	43,5	0	Ph3				
5	43,5	3	G16				
6	37,2	0	Ph2				
7	34,5	0	Ph2				
8	34,5	3	G14				
9	28,2	0	Ph1				
10	25,5	0	Ph1				
11	22,5	0	G12				
12	0	0	PFC1				
13	0	6,1	PFC2				
14	19,5	6,6	S25				
15	22,5	6,6	G25				
16	25,5	8,3	S1sh2				
17	25,5	11,3	S2sh2				
18	0	16,8	DC-Rect				
19	0	19,5	DC-Rect				
20	0	22,5	S2sh1				
21	0	25,5	S1sh1				
22	0	28,5	DC-SH				
23	2,7	28,5	DC-SH				
24	9,8	25,8	PFC+				
25	9,8	28,5	PFC+				
26	20,7	16,5	S27				
27	20,7	19,5	G27				
28	16,9	23,5	S1sh3				
29	16,9	26,5	S2sh3				
30	20,7	28,5	PFC-				
31	23,4	28,5	PFC-				
32	22	25,5	Therm1				
33	22	22,5	Therm2				
34	27	28,5	DC-1				
35	33,5	28,5	S2sh4				
36	33,5	25,5	S1sh4				
37	33,5	22,5	G11				
38	36,5	28,5	DC-2				
39	43	28,5	S2sh5				
40	43	25,5	S1sh5				
41	43	22,5	G13				
42	46	28,5	DC-3				
43	52,5	28,5	S2sh6				
44	52,5	25,5	S1sh6				
45	52,5	22,5	G15				
46	not assembled						



Vincotech

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	30 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	20 A	Inverter Diode	
T25, T27	IGBT	650 V	30 A	PFC Switch	
D25, D27	FWD	600 V	30 A	PFC Diode	
D45, D47	FWD	650 V	6 A	PFC Sw. Protection Diode	
SH4, SH5, SH6	Shunt			Inverter Shunt	
SH2, SH3	Shunt			PFC Shunt	
SH1	Shunt			Shunt	
C25, C27	Capacitor	630 V		Capacitor (PFC)	
Rt	Thermistor			Thermistor	

**10-PG06PPA030SJ01-LH52E08T**

datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow 1 packages see vincotech.com website.

Package data

Package data for flow 1 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-PG06PPA030SJ01-LH52E08T-D1-14	15 Aug. 2022		
10-PG06PPA030SJ01-LH52E08T-D2-14	15 Aug. 2022	Change of PFC Diode	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.